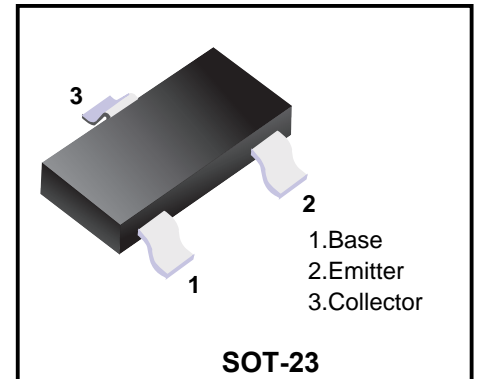


PNP Silicon Epitaxial Transistor



Features

- High DC Current Gain: $h_{FE} = 200$ TYP. ($V_{CE} = -6.0$ V, $I_C = -1.0$ mA)
- High Voltage: $V_{CEO} = -50$ V

Absolute Maximum Ratings ($T_a=25^{\circ}C$)

Parameter	Symbol	Rating	Unit
Collector to base voltage	V_{CBO}	-60	V
Collector to emitter voltage	V_{CEO}	-50	V
Emitter to base voltage	V_{EBO}	-5.0	V
Collector current (DC)	I_C	-100	mA
power dissipation	P_C	200	mW
Junction temperature	T_j	150	$^{\circ}C$
Storage temperature range	T_{stg}	-55 to +150	$^{\circ}C$

Electrical Characteristics ($T_a=25^{\circ}C$ unless otherwise specified.)

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = -60$ V, $I_E = 0$ A			-0.1	μ A
Emitter cutoff current	I_{EBO}	$V_{EB} = -5.0$ V, $I_C = 0$ A			-0.1	μ A
DC current gain *	h_{FE}	$V_{CE} = -6.0$ V, $I_C = -1.0$ mA	90	200	600	
Collector saturation voltage	$V_{CE(sat)}$	$I_C = -100$ mA, $I_B = -10$ mA		-0.18	-0.3	V
Base to emitter voltage	V_{BE}	$V_{CE} = 6.0$ V, $I_C = -1.0$ mA	-0.58	-0.62	-0.68	V
Output capacitance	C_{ob}	$V_{CE} = -10$ V, $I_E = 0$ A, $f = 1.0$ MHz		4.5		pF
Transition frequency	f_T	$V_{CE} = -6.0$ V, $I_E = 10$ mA		180		MHz

* Pulsed: $PW \leq 350 \mu s$, Duty Cycle $\leq 2\%$

hFE Classification

Marking	M4	M5	M6	M7
h_{FE}	90~180	135~270	200~400	300~600

Typical Characteristics

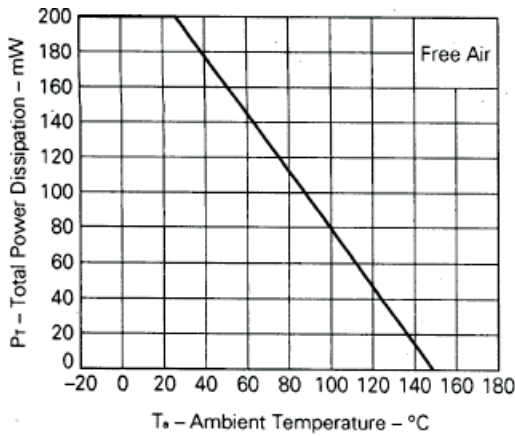


Fig.1 Total Power Dissipation vs. Ambient Temperature

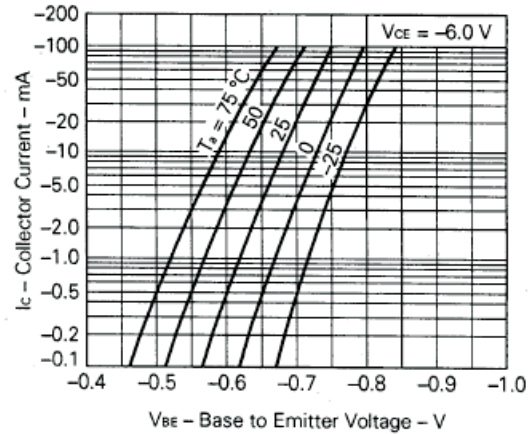


Fig.2 Collector Current vs. Base to Emitter Voltage

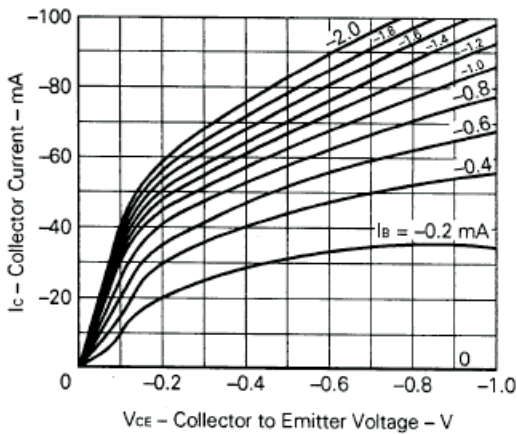


Fig.3 Collector Current vs. Collector to Emitter Voltage

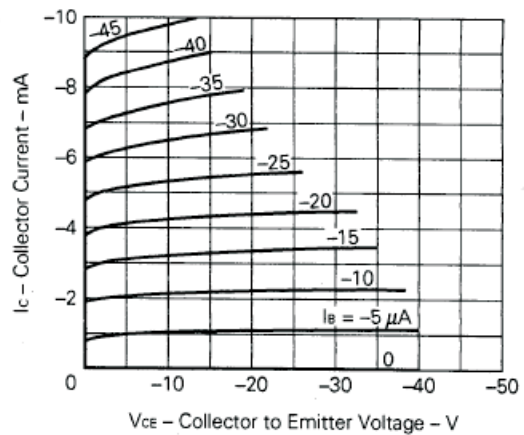


Fig.4 Collector Current vs. Collector to Emitter Voltage

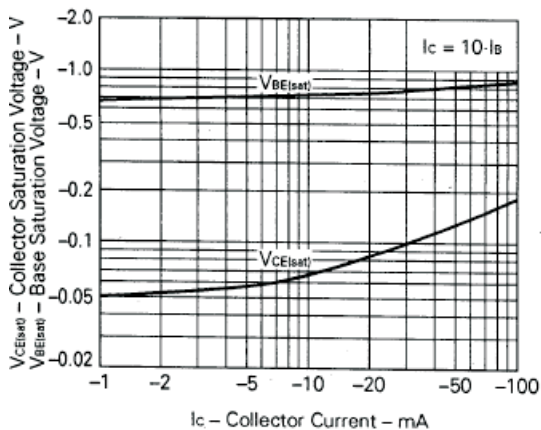


Fig.5 Base and Collector Saturation Voltage vs. Collector Current

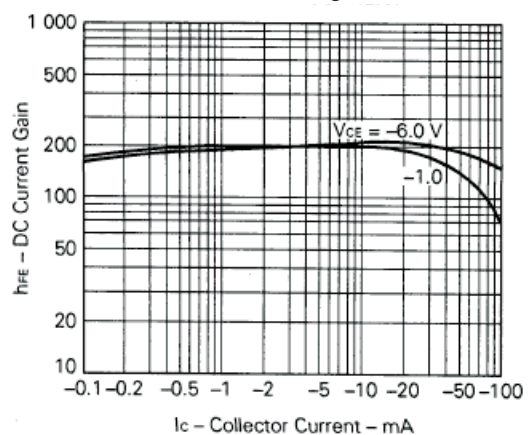


Fig.6 DC Current Gain vs. Collector Current

Ordering information

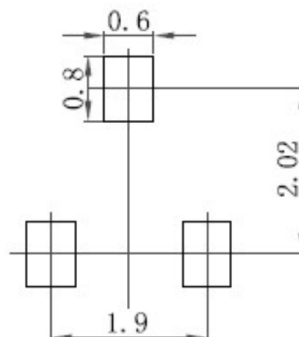
Package	Packing Description	Base Quantity	Packing Quantity
SOT-23	Tape/Reel, 7" reel	3000pcs/Reel	24000PCS/Box 120000PCS/Cartron

Package Dimensions

SOT-23

Dim.	Millimeter (mm)		mil	
	Min.	Max.	Min.	Max.
A	0.9	1.15	35	45
A1	0.1		3.9	
bp	0.38	0.48	15	19
C	0.09	0.15	3.54	5.9
D	2.8	3.0	110	118
E	1.2	1.4	47	55
E	1.9		75	
E1	0.95		37	
HE	2.1	2.55	83	100
Lp	0.15	0.45	5.9	18
Q	0.45	0.55	18	22
v	0.2		7.9	
W	0.1		4	

The recommended mounting pad size



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